Panasonic

2SB0938 (2SB938), 2SB0938A (2SB938A)

Silicon PNP epitaxial planar type Darlington

For power amplification and switching

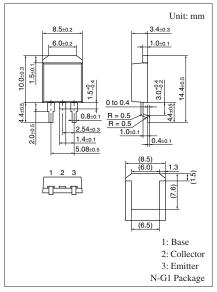
Complementary to 2SD1261, 2SD1261A

Features

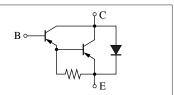
- \bullet High forward current transfer ratio $h_{F\!E}$
- High-speed switching
- N type package enabling direct soldering of the radiating fin to the printed circuit board, etc. of small electronic equipment.

Absolute Maximum Ratings $T_C = 25^{\circ}C$

Parameter	Symbol	Rating	Unit		
Collector-base voltage	2SB0938	V _{CBO}	-60	V	
(Emitter open)	2SB0938A		-80		
Collector-emitter voltage	2SB0938	V _{CEO}	-60	V	
(Base open)	2SB0938A		-80		
Emitter-base voltage (Coll	V _{EBO}	-5	V		
Collector current	I _C	-4	А		
Peak collector current	I _{CP}	-8	А		
Collector power dissipation		P _C	40	W	
	$T_a = 25^{\circ}C$		1.3		
Junction temperature		Tj	150	°C	
Storage temperature		T _{stg}	-55 to +150	°C	



Note) Self-supported type package is also prepared. Internal Connection



Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

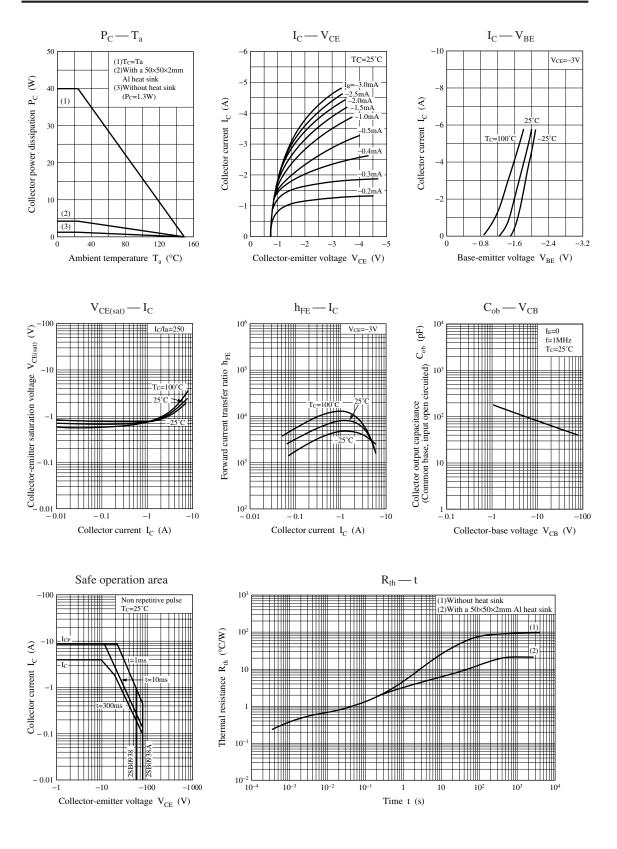
Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage	2SB0938	V _{CEO}	$I_{\rm C} = -30$ mA, $I_{\rm B} = 0$	-60			V
(Base open)	2SB0938A			-80			
Base-emitter voltage		V _{BE}	$V_{CE} = -3 V, I_C = -3 A$			-2.5	V
Collector-base cutoff	2SB0938	I _{CBO}	$V_{CB} = -60 \text{ V}, I_E = 0$			-200	μΑ
current (Emitter open)	2SB0938A		$V_{CB} = -80 \text{ V}, I_E = 0$			-200	
Collector-emitter cutoff	2SB0938	I _{CEO}	$V_{CE} = -30 \text{ V}, I_B = 0$			-500	μΑ
current (Base open)	2SB09378		$V_{CE} = -40 \text{ V}, I_B = 0$			-500	
Emitter-base cutoff current (Collector open)		I _{EBO}	$V_{EB} = -5 V, I_C = 0$			-2	mA
Forward current transfer ratio		h _{FE1}	$V_{CE} = -3 \text{ V}, I_C = -0.5 \text{ A}$	1 0 0 0			
		h _{FE2} *	$V_{CE} = -3 V, I_C = -3 A$	2000		10000	
Collector-emitter saturation voltage		V _{CE(sat)}	$I_{\rm C} = -3$ A, $I_{\rm B} = -12$ mA			-2	V
			$I_{\rm C} = -5$ A, $I_{\rm B} = -20$ mA			-4	
Transition frequency		f _T	$V_{CE} = -10 \text{ V}, I_C = -0.5 \text{ A}, f = 1 \text{ MHz}$		15		MHz
Turn-on time		t _{on}	$I_{\rm C} = -3$ A,		0.3		μs
Strage time		t _{stg}	$I_{B1} = -12 \text{ mA}, I_{B2} = 12 \text{ mA}$		2		μs
Fall time		t _f	$V_{CC} = -50 \text{ V}$		0.5		μs

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors. 2. *: Rank classification

 Rank
 Q
 P

 h_{FE1}
 2000 to 5000
 4000 to 10000
 Note) The part number in the parenthesis shows conventional part number.

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